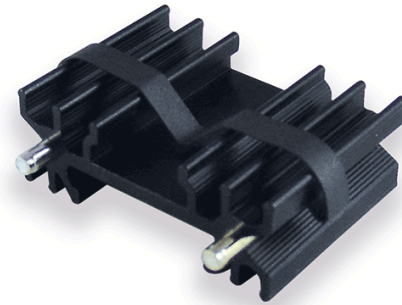


Product features PR

28/25/MC

Semiconductor casing:	TO-220 ; TO-218 ; TOP-3 ; TO-202
Semiconductor mounted by:	Clip Mounting
Heat sink mounted by:	Solder
Finish	Black Anodised
Material	AlMgSi0,5
Width [mm]:	34.5
Height [mm]:	12.5
Length [mm]:	25.0
Min. thermal resistance [K/W]:	13.0



Further information

- Special extruded heatsink for semiconductor case TO220, TO202, TO218(TOP3) - Aluminium, anodised black, solderable - Standard heights: 25, 38, 50 and 63 mm - Version MC (Mounting clip) for clip mounting of semiconductor. - Heatsink solderable by tin plated solder pins

